International TOR Rectifier

POWER MOSFET THRU-HOLE (MO-036AB)

Product Summary

Part Number	RDS(on)	ΙD
IRFG9110	1.4Ω	-0.75A

HEXFET® MOSFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry design achieves very low on-state resistance combined with high transconductance. HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, high energy pulse circuits, and virtually any application where high reliability is required. The HEXFET transistor's totally isolated package eliminates the need for additional isolating material between the device and the heatsink. This improves thermal efficiency and reduces drain capacitance.

IRFG9110 JANTX2N7335 JANTXV2N7335 REF:MIL-PRF-19500/599 100V, QUAD P-CHANNEL HEXFET® MOSFETTECHNOLOGY



Features:

- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Electrically Isolated
- Dynamic dv/dt Rating
- Light-weight

Absolute Maximum Ratings

	Parameter		Units
ID @ VGS = -10V, TC = 25°C Continuous Drain Current		-0.75	
ID @ VGS = -10V, TC = 100°C	Continuous Drain Current	-0.5	Α
IDM	Pulsed Drain Current ①	-3.0	
P _D @ T _C = 25°C	Max. Power Dissipation	1.4	W
	Linear Derating Factor	0.011	W/°C
VGS	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	75	mJ
IAR	Avalanche Current ①	_	Α
EAR	Repetitive Avalanche Energy ①	_	mJ
dv/dt	Peak Diode Recovery dv/dt 3	-5.5	V/ns
TJ	Operating Junction	-55 to 150	
TSTG Storage Temperature Range			°C
	Lead Temperature	300 (0.063 in.(1.6mm) from case for 10s)	
	Weight	1.3 (typical)	g

For footnotes refer to the last page

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

	Parameter	Min	Тур	Max	Units	Test Conditions
BVDSS	Drain-to-Source Breakdown Voltage	-100	_		V	VGS = 0V, ID = -1.0mA
ΔBV _{DSS} /ΔT _J	Temperature Coefficient of Breakdown Voltage	_	-0.098	_	V/°C	Reference to 25°C, I _D = -1.0mA
RDS(on)	Static Drain-to-Source On-State	_	_	1.4	Ω	Vgs = -10V, ID = -0.5A4
	Resistance	_	_	1.73	1 52	VGS = -10V, ID = -0.75A ④
VGS(th)	Gate Threshold Voltage	-2.0	_	-4.0	V	V _{DS} = V _{GS} , I _D = -250μA
9fs	Forward Transconductance	0.67	_	_	S (U)	V _{DS} > -15V, I _{DS} = -0.5A ⁽⁴⁾
IDSS	Zero Gate Voltage Drain Current	_	_	-25		V _{DS} = -80V, V _{GS} = 0V
		_	_	-250	μΑ	V _{DS} = -80V
						VGS = 0V, TJ = 125°C
IGSS	Gate-to-Source Leakage Forward	_	_	-100	nA	VGS = -20V
IGSS	Gate-to-Source Leakage Reverse	_	_	100	''^	V _{GS} =20V
Qg	Total Gate Charge	_	_	15		$V_{GS} = -10V, ID_{=} -0.75A$
Qgs	Gate-to-Source Charge	_	_	7.0	nC	V _{DS} = -50V
Q _{gd}	Gate-to-Drain ('Miller') Charge	_	_	8.0]	
td(on)	Turn-On Delay Time	_	_	30		$V_{DD} = -50V, I_{D} = -0.75A$
tr	Rise Time	_	_	60	ns	$V_{GS} = -10V$, $R_{G} = 7.5\Omega$
td(off)	Turn-Off Delay Time	_	_	40	1115	
tf	Fall Time	_	_	40		
LS + LD	Total Inductance	_	10	_	nΗ	Measured from drain lead (6mm/ 0.25in. from package) to source lead (6mm/0.25in. from package)
Ciss	Input Capacitance	_	200			VGS = 0V, VDS = -25V
Coss	Output Capacitance	_	85		pF	f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	_	30	_		

Source-Drain Diode Ratings and Characteristics

<u> </u>							
	Parameter		Min	Тур	Max	Units	Test Conditions
Is	Continuous Source Current (Body Diode)	_	_	-0.75	Α	
ISM	Pulse Source Current (Body	Diode) ①	_	_	-3.0		
VSD	Diode Forward Voltage		_	_	-5.5	V	$T_j = 25$ °C, $I_S = -0.75$ A, $V_{GS} = 0$ V $\textcircled{4}$
t _{rr}	Reverse Recovery Time		_	_	200	nS	Tj = 25°C, IF = -0.75A, di/dt ≤-100A/μs
QRR	Reverse Recovery Charge		_	_	9.0	μc	V _{DD} ≤ -50V ④
ton	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_S + L_D$.					

Thermal Resistance

	Parameter	Min	Тур	Max	Units	Test Conditions
RthJC	Junction-to-Case	_	_	17	°C/W	
R _{th} JA	Junction to Ambient	_	_	90		Typical socket mount

Note: Corresponding Spice and Saber models are available on the G&S Website.

For footnotes refer to the last page

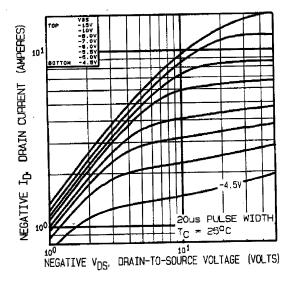


Fig 1. Typical Output Characteristics

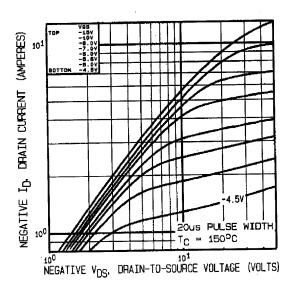


Fig 2. Typical Output Characteristics

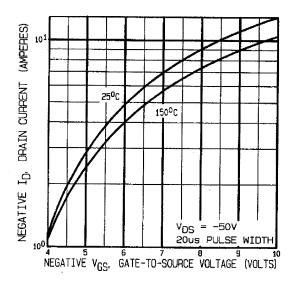


Fig 3. Typical Transfer Characteristics

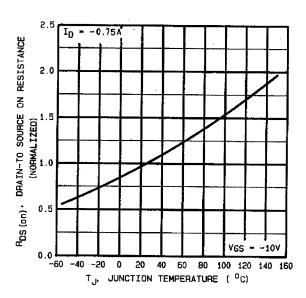
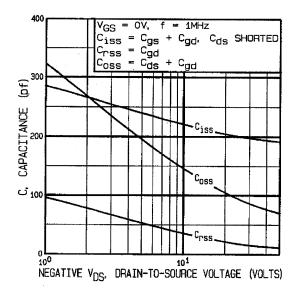


Fig 4. Normalized On-Resistance Vs. Temperature



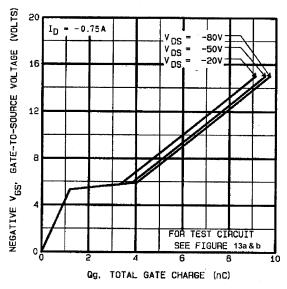
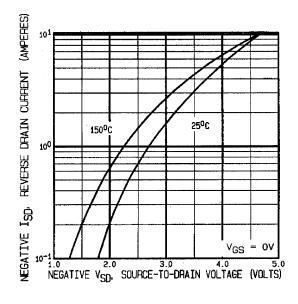


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage





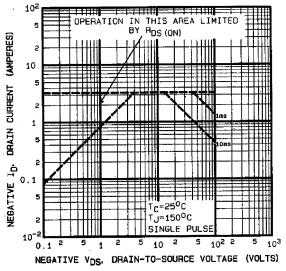


Fig 8. Maximum Safe Operating Area



IRFG9110

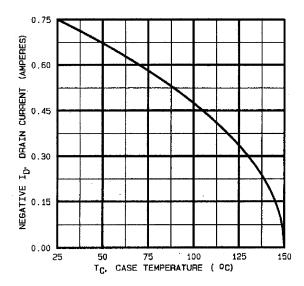


Fig 9. Maximum Drain Current Vs. Case Temperature

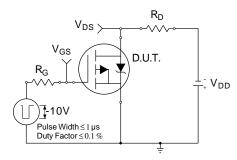


Fig 10a. Switching Time Test Circuit

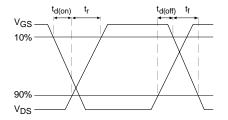


Fig 10b. Switching Time Waveforms

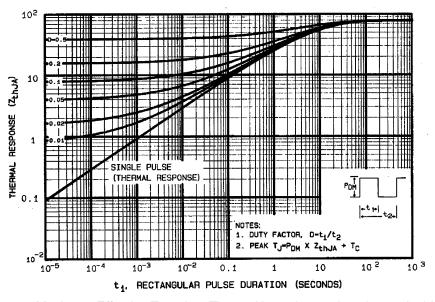


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

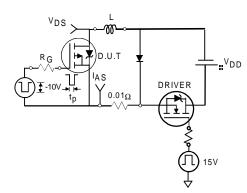


Fig 12a. Unclamped Inductive Test Circuit

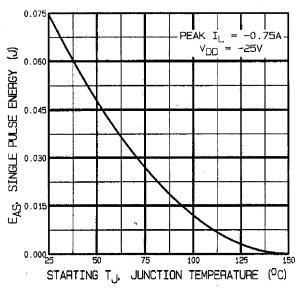


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

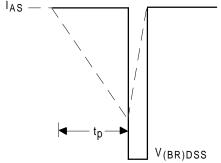


Fig 12b. Unclamped Inductive Waveforms

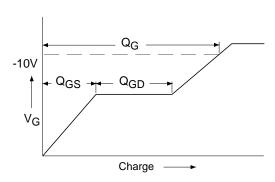


Fig 13a. Basic Gate Charge Waveform

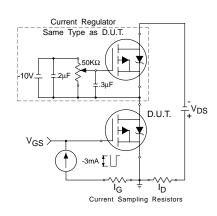


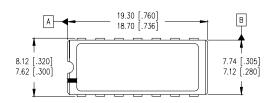
Fig 13b. Gate Charge Test Circuit

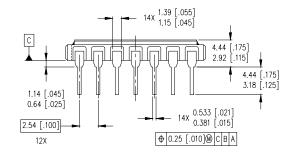


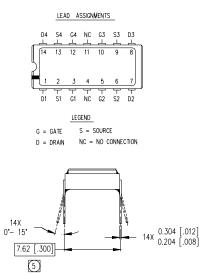
Foot Notes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ② V_{DD} =-25V, starting T_J = 25°C, L = 266mH Peak I_I = -0.75A, V_{GS} = -10V
- $\label{eq:sp} \begin{tabular}{ll} \begin{t$
- ④ Pulse width ≤ 300 μ s; Duty Cycle ≤ 2%

Case Outline and Dimensions — MO-036AB







NOTES:

- 1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MO-036AB.
- MEASURED WITH THE LEADS CONSTRAINED TO BE PERPENDICULAR TO DATUM PLANE C.

International Rectifier

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Data and specifications subject to change without notice. 04/02